STP77N6F6



N-channel 60 V, 0.0063 Ω typ., 77 A STripFET™ VI DeepGATE™ Power MOSFET in a TO-220 package

Datasheet - production data

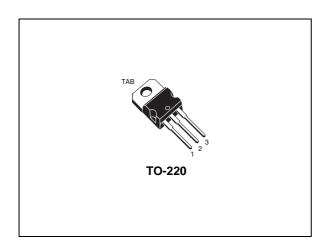
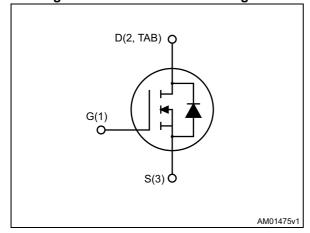


Figure 1. Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max	I _D	P _{TOT}
STP77N6F6	60 V	$0.007~\Omega$	77 A	80 W

- $\bullet \quad \mathsf{R}_{\mathsf{DS}(\mathsf{on})} \ ^* \ \mathsf{Q}_\mathsf{g} \ \mathsf{industry} \ \mathsf{benchmark}$
- Extremely low on-resistance R_{DS(on)}
- High avalanche ruggedness
- Low gate drive power losses
- · Very low switching gate charge

Applications

· Switching applications

Description

This device is an N-channel Power MOSFET developed using the 6^{th} generation of STripFETTM DeepGATETM technology, with a new gate structure. The resulting Power MOSFET exhibits the lowest $R_{DS(on)}$ in all packages.

Table 1. Device summary

Order code	Order code Marking Package		Packaging
STP77N6F6	77N6F6	TO-220	Tube

Contents STP77N6F6

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STP77N6F6 Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage	60	V
V _{GS}	Gate-source voltage	±20	V
I _D ⁽¹⁾	Drain current (continuous) at T _c = 25 °C	77	Α
I _D ⁽¹⁾	Drain current (continuous) at T _c = 100 °C	55	Α
I _{DM} ⁽²⁾	Drain current (pulsed)	308	Α
P _{TOT} (1)	Total dissipation at T _c = 25 °C	80	W
T _{J Pstg} Operating junction temperature storage temperature		-55 to 175	°C

^{1.} This value is rated according to $R_{\text{thj-c}}$

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-c}	Thermal resistance junction-case	1.88	°C/W
R _{thj-a} ⁽¹⁾	Thermal resistance junction-ambient	62.5	C/VV

^{1.} When mounted on FR-4 board of 1 inch², 2 oz Cu, t < 10 sec

Table 4. Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AV}	Avalanche current, repetitive or not-repetitive (pulse width limited by maximum junction temperature)	38.5	А
E _{AS}	Single pulse avalanche energy $(T_J = 25 \text{ °C}, I_D = I_{AV}, V_{DD} = 43 \text{ V})$	152	mJ

^{2.} Pulse width is limited by safe operating area

Electrical characteristics STP77N6F6

2 Electrical characteristics

(T_J= 25 °C unless otherwise specified)

Table 5. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_D = 250 \mu A, V_{GS} = 0$	60			٧
	Zero gate voltage Drain current	V _{DS} = 60 V, V _{GS} = 0			10	μΑ
I _{DSS}		V _{DS} = 60 V, V _{GS} = 0, T _J =125 °C			100	μA
I _{GSS}	Gate-body leakage current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0$			± 100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	2		4	V
R _{DS(on)}	Static drain-source on- resistance	V _{GS} = 10 V, I _D = 38.5 A		0.0063	0.007	Ω

Table 6. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	4295	-	pF
C _{oss}	Output capacitance	$V_{DS} = 25 \text{ V, f} = 1 \text{ MHz,}$	-	292	-	pF
C _{rss}	Reverse transfer capacitance	$V_{GS} = 0$	i	190	-	pF
Q_g	Total gate charge	V 00 V 1 77 A	-	70.5	-	nC
Q _{gs}	Gate-source charge	$V_{DD} = 30 \text{ V}, I_{D} = 77 \text{ A},$ $V_{GS} = 10 \text{ V}$	-	19.7	-	nC
Q_{gd}	Gate-drain charge	163 10 1	1	16.2	ı	nC
R_{g}	Intrinsic gate resistance	f = 1 MHz open drain	-	2.2	-	Ω

Table 7. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time		-	22	-	ns
t _r	Rise time	V _{DD} = 30 V, I _D = 77 A	-	42	-	ns
t _{d(off)}	Turn-off-delay time	$R_G = 4.7 \Omega V_{GS} = 10 V$	-	73	-	ns
t _f	Fall time		-	16	-	ns

Table 8. Source drain diode

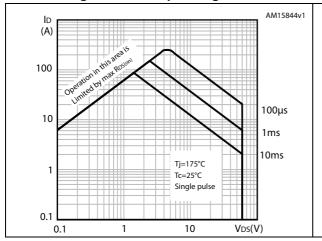
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		77	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		308	Α
V _{SD} (2)	Forward on voltage	I _{SD} = 77 A, V _{GS} = 0	-		1.3	٧
t _{rr}	Reverse recovery time	I _{SD} = 77 A, V _{DD} = 48 V	-	49		ns
Q _{rr}	Reverse recovery charge	di/dt = 100 A/µs,	-	8.5		nC
I _{RRM}	Reverse recovery current	T _j = 25 °C	-	0.3		Α

- 1. Pulse width is limited by safe operating area
- 2. Pulse test: pulse duration = $300 \mu s$, duty cycle 1.5%

Electrical characteristics STP77N6F6

Electrical characteristics (curves) 2.1

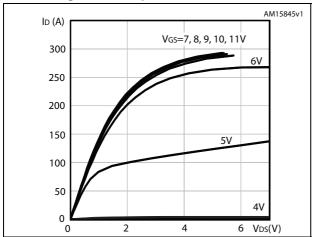
Figure 2. Safe operating area Figure 3. Thermal impedance



 $\delta = 0.5$ 10 -1 $Z_{th} = k R_{thJ-c}$ 0.01 $\delta = \, t_{\rm p} \, / \tau$ SINGLE PULSE 10⁻¹ † p (s) 10-4 10-3 10-2

Figure 4. Output characteristics

Figure 5. Transfer characteristics



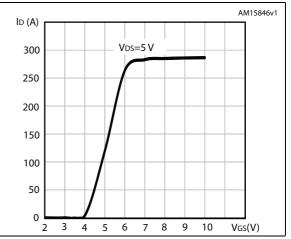
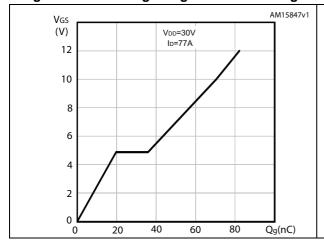


Figure 6. Gate charge vs gate-source voltage

Figure 7. Static drain-source on-resistance



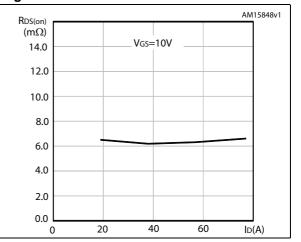
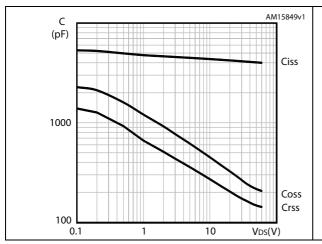


Figure 8. Capacitance variations

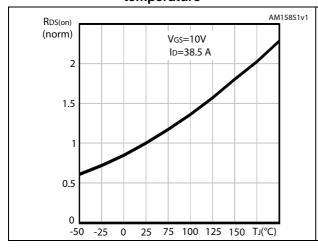
Figure 9. Normalized gate threshold voltage vs. temperature



VGS(th) (norm)
1.2 ID=250μA
0.8
0.6
0.4
0.2
0
-50 -25 0 25 50 75 100 125 TJ(°C)

Figure 10. Normalized on-resistance vs. temperature

Figure 11. Drain-source diode forward characteristics



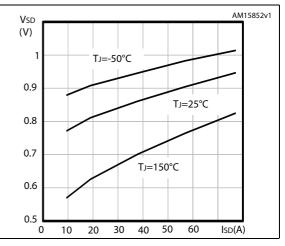
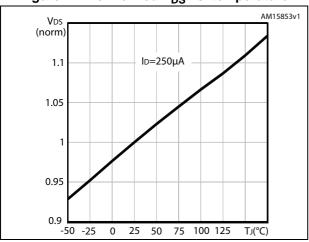


Figure 12. Normalized V_{DS} vs. temperature



Test circuits STP77N6F6

3 Test circuits

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

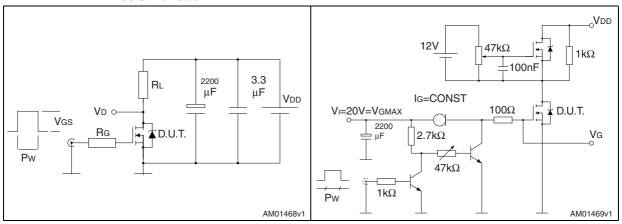


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped inductive load test circuit

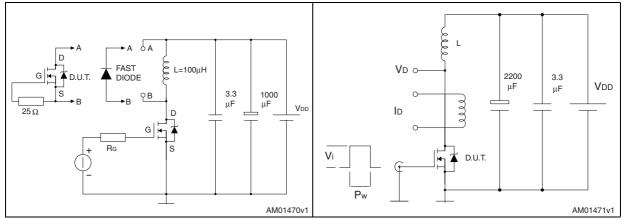
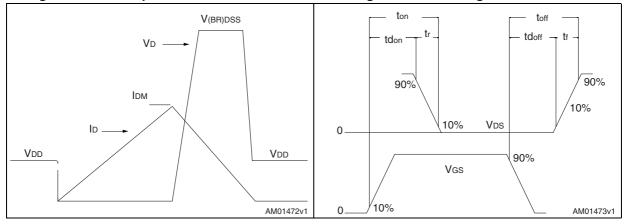


Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform



4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.



Table 9. TO-220 type A mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
А	4.40		4.60
b	0.61		0.88
b1	1.14		1.70
С	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10		10.40
е	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13		14
L1	3.50		3.93
L20		16.40	
L30		28.90	
ØP	3.75		3.85
Q	2.65		2.95

Figure 19. TO-220 type A drawing

Revision history STP77N6F6

5 Revision history

Table 10. Document revision history

Date	Revision	Changes
12-Dec-2012	1	First release.
23-May-2013	2	 Updated: values in <i>Table 4</i>, the entire values in <i>Table 6</i>, 7, V_{DD} and T_J values in <i>Table 8</i>, typical values for t_{rr}, Q_{rr}, I_{RRM} in <i>Table 8</i> Added: V_{SD} max value in <i>Table 8</i> Added: Section 2.1: Electrical characteristics (curves) Minor text changes

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